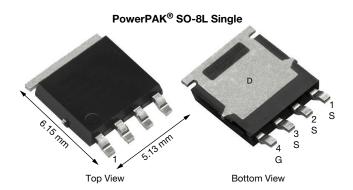


www.vishay.com

Vishay Siliconix

Automotive N-Channel 80 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY				
V _{DS} (V)	80			
$R_{DS(on)}$ (Ω) at $V_{GS} = 10 \text{ V}$	0.0053			
I _D (A)	72			
Configuration	Single			
Package	PowerPAK SO-8L			

FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912





ROHS COMPLIANT HALOGEN FREE

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N-Channel MOSFET	o _s

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage	V _{DS}	80			
Gate-source voltage	V_{GS}	± 20	V		
Continuous drain current	T _C = 25 °C	ı	72	А	
	T _C = 125 °C	I _D	41.5		
Continuous source current (diode conduction)		I _S	62		
Pulsed drain current ^a		I _{DM}	288	l	
Single pulse avalanche current	L = 0.1 mH	I _{AS}	37		
Single pulse avalanche energy	L=0.1 min	E _{AS}	68.4	mJ	
Maximum power dissipation ^a	T _C = 25 °C		68	14/	
	T _C = 125 °C	P_{D}	22	W	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	%0	
Soldering recommendations (peak temperature) c, d			260	°C	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount b	R_{thJA}	68	°C/W
Junction-to-case (drain)		R_{thJC}	2.2	C/VV

Notes

- a. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$
- b. When mounted on 1" square PCB (FR4 material)
- c. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- d. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components



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PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static				l		l	L
Drain-source breakdown voltage	V _{DS}	V _{GS}	= 0, I _D = 250 μA	80	-	-	V
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	2.3	2.8	3.3	V
Gate-source leakage	I _{GSS}	V _{DS} =	0 V, V _{GS} = ± 20 V	-	-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = 80 V	-	-	1	
Zero gate voltage drain current	I_{DSS}	V _{GS} = 0 V	V _{DS} = 80 V, T _J = 125 °C	-	-	50	μΑ
		V _{GS} = 0 V	V _{DS} = 80 V, T _J = 175 °C	-	-	500	
On-state drain current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	30	-	-	Α
		V _{GS} = 10 V	I _D = 10 A	-	0.00432	0.00530	
Drain-source on-state resistance a	R _{DS(on)}	V _{GS} = 10 V	I _D = 10 A, T _J = 125 °C	-	-	0.00970	Ω
		V _{GS} = 10 V	I _D = 10 A, T _J = 175 °C	-	-	0.01210	
Forward transconductance b	9 _{fs}	V_{DS}	= 15 V, I _D = 10 A	-	51	-	S
Dynamic ^b							
Input capacitance	C _{iss}			-	3767	5100	
Output capacitance	C _{oss}	$V_{GS} = 0 V$	$V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	-	700	950	pF
Reverse transfer capacitance	C_{rss}			-	45	65	
Total gate charge ^c	Qg			-	62	95	
Gate-source charge ^c	Q _{gs}	V _{GS} = 10 V	$V_{DS} = 40 \text{ V}, I_{D} = 10 \text{ A}$	-	16	-	nC
Gate-drain charge ^c	Q _{gd}			-	13	-	
Gate resistance	R_g		f = 1 MHz	0.25	0.52	0.80	Ω
Turn-on delay time ^c	t _{d(on)}			-	16	30	
Rise time ^c	t _r		= 40 V, $R_L = 4 \Omega$	-	5	10	,,
Turn-off delay time ^c	t _{d(off)}	$I_D \cong 10 A$,	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	29	50	ns
Fall time ^c	t _f	1		-	7	15	
Source-Drain Diode Ratings and Charac	cteristics ^b						
Pulsed current ^a	I _{SM}			-	-	288	Α
Forward voltage	V _{SD}	I _F :	= 10 A, V _{GS} = 0	-	0.8	1.2	V
Body diode reverse recovery time	t _{rr}			-	51	110	ns
Body diode reverse recovery charge	Q _{rr}] , ,	۸ ما:/م اد ۱۰۰۰ ۸/۰۰۰	-	87	180	nC
Reverse recovery fall time	ta	I _F = 8	A, di/dt = 100 A/μs	-	39	-	
Reverse recovery rise time	t _b	1		-	12	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			-	-3	-	Α

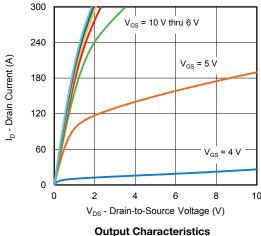
Notes

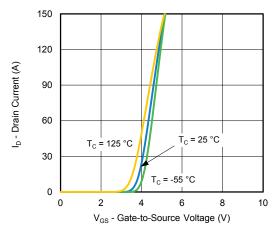
- a. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

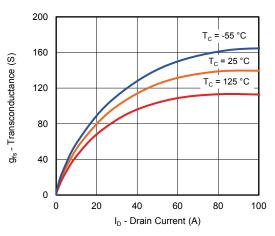


TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

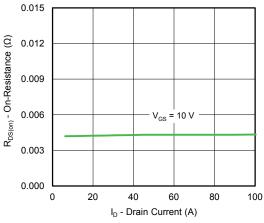




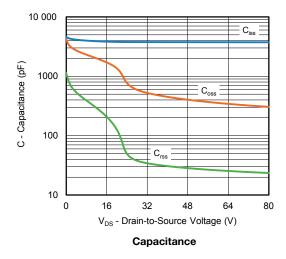
Transfer Characteristics

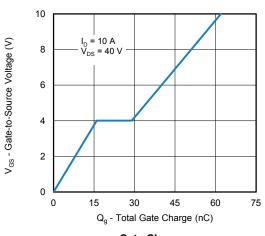


Transconductance



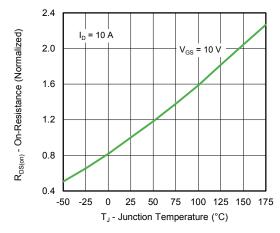
On-Resistance vs. Drain Current



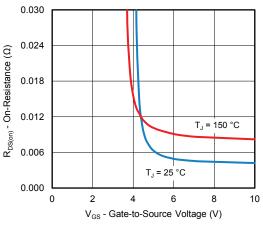




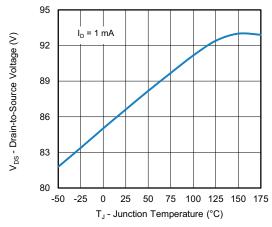
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



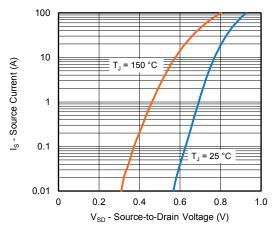
On-Resistance vs. Junction Temperature



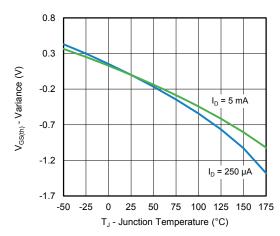
On-Resistance vs. Gate-to Source Voltage



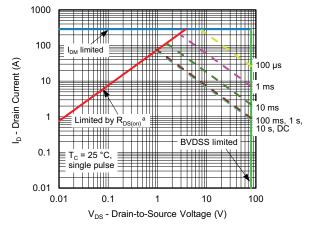
Drain Source Breakdown vs. Junction Temperature



Source Drain Diode Forward Voltage



Threshold Voltage



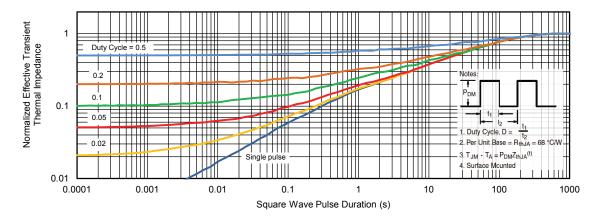
Safe Operating Area

Note

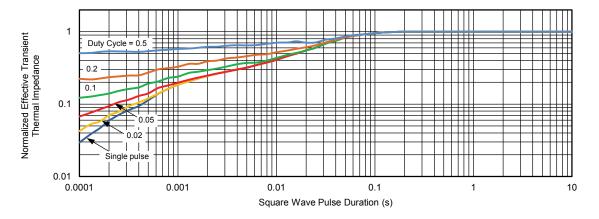
a. V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

For technical questions, contact: automostech

TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

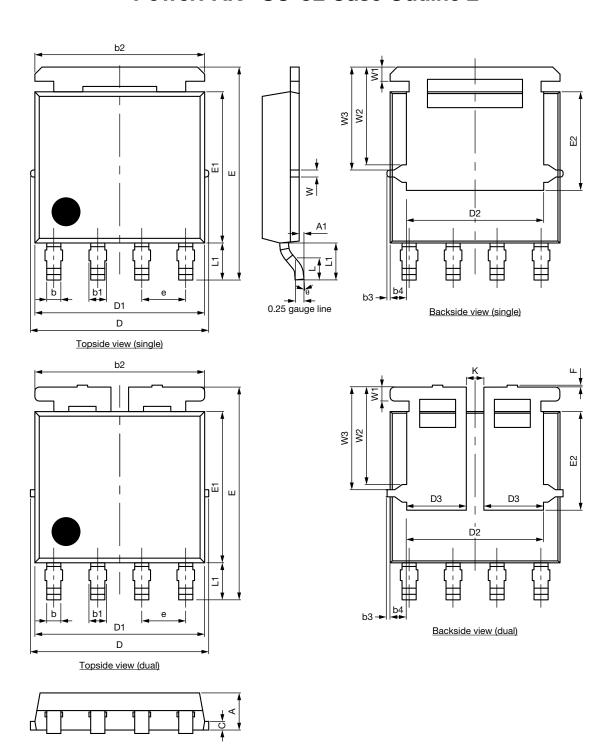
Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?76888.



PowerPAK® SO-8L Case Outline 2



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DIM.		MILLIMETERS			INCHES		
DIN.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	-	0.127	0.00	-	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094		0.004			
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е		1.27 BSC		0.050 BSC			
Е	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	2.75	2.85	2.95	0.108	0.112	0.116	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
K		0.51			0.020		
W		0.23		0.009			
W1	0.41		0.016				
W2	2.82		0.111				
W3		2.96			0.117		
θ	0°	-	10°	0°	-	10°	

ECN: C21-1498-Rev. C, 01-Nov-2021

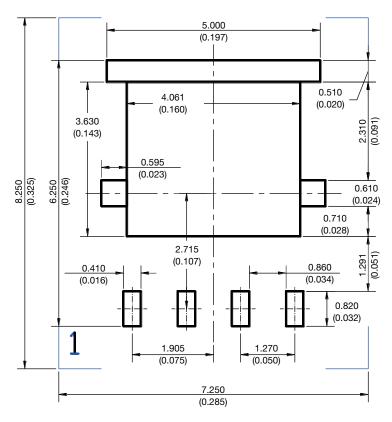
DWG: 6044

Note

• Millimeters will govern



RECOMMENDED MINIMUM PAD FOR PowerPAK® SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)



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